

IGBT - Field Stop, Trench 650 V, 75 A FGH75T65SQDT

Description

Using novel field stop IGBT technology, **onsemi**'s new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

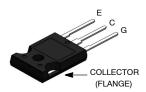
- Max Junction Temperature $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.6 \text{ V (Typ.)}$ @ $I_C = 75 \text{ A}$
- 100% of the Parts Tested for I_{LM}
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC

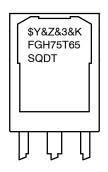
| V _{CES} | I _C |
|------------------|----------------|
| 650 V | 75 A |





TO-247-3LD CASE 340CH

MARKING DIAGRAM



FGH75T65SQDT = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

| Symbol | Description | | FGH50T65SQD-F155 | Unit |
|--------------------------|--|-----------------------------------|------------------|------|
| V _{CES} | Collector to Emitter Voltage | | 650 | V |
| V _{GES} | Gate to Emitter Voltage | | ±20 | V |
| | Transient Gate to Emitter Voltage | | ±30 | V |
| I _C | Collector Current | T _C = 25°C | 150 | Α |
| | | T _C = 100°C | 75 | Α |
| I _{LM} (Note 1) | Pulsed Collector Current | T _C = 25°C | 300 | Α |
| I _{CM} (Note 2) | Pulsed Collector Current | | 300 | Α |
| I _F | Diode Forward Current | T _C = 25°C | 150 | Α |
| | Diode Forward Current | T _C = 100°C | 75 | Α |
| I _{FM} | Pulsed Diode Maximum Forward Curren | t | 300 | Α |
| P_{D} | Maximum Power Dissipation | T _C = 25°C | 375 | W |
| | | T _C = 100°C | 188 | W |
| TJ | Operating Junction Temperature | | −55 to +175 | °C |
| T _{STG} | Storage Temperature Range | | -55 to +175 | °C |
| TL | Maximum Lead Temp. for Soldering Purpo | ses, 1/8" from Case for 5 Seconds | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $V_{CC} = 400 \text{ V}$, $V_{GE} = 15 \text{ V}$, $I_{C} = 300 \text{ A}$, $R_{G} = 21 \Omega$, Inductive Load.

2. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

| Symbol | Parameter | FGH75T65SQDT-F155 | Unit |
|--------------------------|---|-------------------|------|
| R _{θJC} (IGBT) | Thermal Resistance, Junction to Case, Max. | 0.4 | °C/W |
| R _{θJC} (Diode) | Thermal Resistance, Junction to Case, Max. | 0.65 | °C/W |
| $R_{	heta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | °C/W |

PACKAGE MARKING AND ORDERING INFORMATION

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Qty per Tube |
|-------------------|--------------|------------|-------------------|-----------|------------|--------------|
| FGH75T65SQDT-F155 | FGH75T65SQDT | TO-247-3LD | Tube | _ | Ì | 30 |

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|--------------------------------|--|--|-----|------|------|------|
| OFF CHARACT | ERISTICS | | | • | | • |
| BV _{CES} | Collector to Emitter Breakdown Voltage | $V_{GE} = 0 \text{ V}, I_{C} = 1 \text{ mA}$ | 650 | _ | - | V |
| $\Delta BV_{CES}/\Delta T_{J}$ | Temperature Coefficient of Breakdown Voltage | I _C = 1 mA, Reference to 25°C | - | 0.6 | - | V/°C |
| I _{CES} | Collector Cut-Off Current | V _{CE} = V _{CES} , V _{GE} = 0 V | - | _ | 250 | μΑ |
| I _{GES} | G-E Leakage Current | $V_{GE} = V_{GES}, V_{CE} = 0 V$ | _ | _ | ±400 | nA |
| ON CHARACTE | ERISTICS | | | | - | |
| V _{GE(th)} | G-E Threshold Voltage | I_C = 75 mA, V_{CE} = V_{GE} | 2.6 | 4.5 | 6.4 | V |
| V _{CE(sat)} | Collector to Emitter Saturation Voltage | I _C = 75 A, V _{GE} = 15 V, T _C = 25 °C | - | 1.6 | 2.1 | V |
| | | I _C = 75 A, V _{GE} = 15 V, T _C = 175°C | - | 1.92 | _ | V |
| DYNAMIC CHA | RACTERISTICS | | | | | |
| C _{ies} | Input Capacitance | V _{CE} = 30 V, V _{GE} = 0 V, f = 1MHz | - | 4845 | - | pF |
| C _{oes} | Output Capacitance | | - | 155 | _ | pF |
| C _{res} | Reverse Transfer Capacitance | | - | 14 | - | pF |
| SWITCHING CH | HARACTERISTICS | | | | | |
| T _{d(on)} | Turn-On Delay Time | V_{CC} = 400 V, I_{C} = 18.8 A, R_{G} = 4.7 Ω , V_{GE} = 15 V, Inductive Load, T_{C} = 25°C | - | 23 | - | ns |
| T _r | Rise Time | | - | 10 | _ | ns |
| T _{d(off)} | Turn-Off Delay Time | | - | 120 | _ | ns |
| T _f | Fall Time | | - | 7 | - | ns |
| E _{on} | Turn-On Switching Loss |] [| - | 300 | - | μЈ |
| E _{off} | Turn-Off Switching Loss | | - | 70 | - | μЈ |
| E _{ts} | Total Switching Loss | | - | 370 | - | μJ |
| $T_{d(on)}$ | Turn-On Delay Time | V_{CC} = 400 V, I_{C} = 37,5 A, R_{G} = 4.7 Ω , V_{GE} = 15 V, | - | 26 | - | ns |
| T _r | Rise Time | Inductive Load, T _C = 25°C | - | 19 | - | ns |
| T _{d(off)} | Turn-Off Delay Time | 7 | - | 114 | - | ns |
| T _f | Fall Time | | - | 11 | _ | ns |
| E _{on} | Turn-On Switching Loss | | - | 746 | _ | μJ |
| E _{off} | Turn-Off Switching Loss | | - | 181 | _ | μJ |
| E _{ts} | Total Switching Loss | | - | 927 | - | μJ |
| $T_{d(on)}$ | Turn-On Delay Time | V_{CC} = 400 V, I_{C} = 18.5 A, R_{G} = 4.7 Ω , V_{GE} = 15 V, | - | 22 | - | ns |
| T _r | Rise Time | Inductive Load, T _C = 175°C | _ | 12 | - | ns |
| $T_{d(off)}$ | Turn-Off Delay Time |] | - | 135 | - | ns |
| T _f | Fall Time | _[| - | 14 | _ | ns |
| E _{on} | Turn-On Switching Loss | | - | 760 | - | μЈ |
| E _{off} | Turn-Off Switching Loss |] [| - | 180 | - | μJ |
| E _{ts} | Total Switching Loss | - | _ | 940 | _ | μJ |

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|---------------------------|--------------------------|--|-----|------|-----|------|
| SWITCHING CHARACTERISTICS | | | | | | |
| T _{d(on)} | Turn-On Delay Time | $V_{CC} = 400 \text{ V}, I_C = 37.5 \text{ A}, R_G = 4.7 \Omega, V_{GE} = 15 \text{ V},$ | - | 24 | - | ns |
| T _r | Rise Time | Inductive Load, T _C = 175°C | - | 24 | _ | ns |
| T _{d(off)} | Turn-Off Delay Time | | | 125 | _ | ns |
| T _f | Fall Time | | - | 10 | - | ns |
| E _{on} | Turn-On Switching Loss | | - | 1520 | ı | μЈ |
| E _{off} | Turn-Off Switching Loss | | | 401 | - | μJ |
| E _{ts} | Total Switching Loss | | - | 1921 | - | μJ |
| Qg | Total Gate Charge | $V_{CE} = 400 \text{ V, } I_{C} = 75 \text{ A,}$ $V_{GE} = 15 \text{ V}$ | | 128 | - | nC |
| Q _{ge} | Gate to Emitter Charge | 1 V GE - 10 V | - | 23 | - | nC |
| Q _{gc} | Gate to Collector Charge | | - | 29 | - | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Test Co | Test Conditions | | Тур | Max | Unit |
|------------------|-------------------------------|--|------------------------|---|------|-----|------|
| V_{FM} | Diode Forward Voltage | I _F = 75 A | T _C = 25°C | - | 1.8 | 2.1 | V |
| | | | T _C = 175°C | - | 1.7 | - | |
| E _{rec} | Reverse Recovery Energy | I _F = 75 A, dI _F /dt = 200 A/μs | T _C = 175°C | - | 160 | - | μJ |
| T _{rr} | Diode Reverse Recovery Time | αιργαί = 200 Αγμο | T _C = 25°C | - | 76 | - | ns |
| | | | T _C = 175°C | - | 270 | - | |
| Q _{rr} | Diode Reverse Recovery Charge | 1 | T _C = 25°C | - | 206 | - | nC |
| | | | T _C = 175°C | - | 2199 | - | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

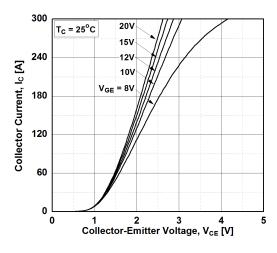


Figure 1. Typical Output Characteristics

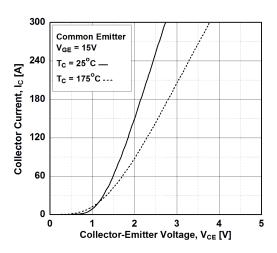


Figure 3. Typical Saturation Voltage Characteristics

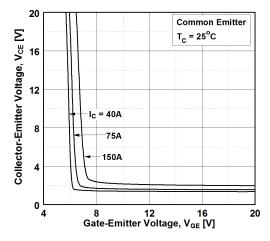


Figure 5. Saturation Voltage vs. V_{GE}

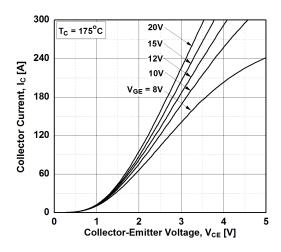


Figure 2. Typical Output Characteristics

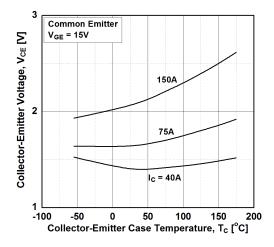


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

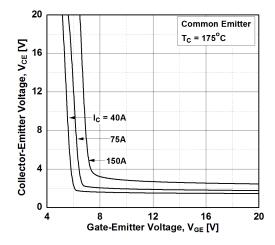


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL CHARACTERISTICS (Continued)

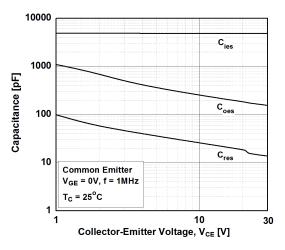


Figure 7. Capacitance Characteristics

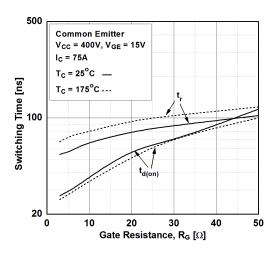


Figure 9. Turn-on Characteristics vs.
Gate Resistance

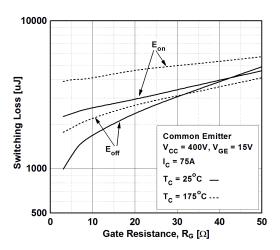


Figure 11. Switching Loss vs.
Gate Resistance

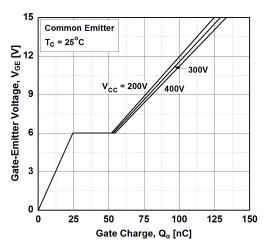


Figure 8. Gate Charge Characteristics

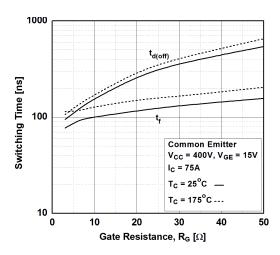


Figure 10. Turn-off Characteristics vs. Gate Resistance

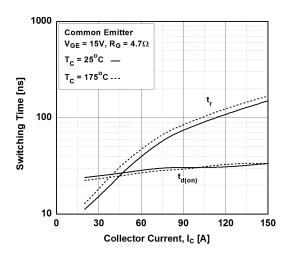


Figure 12. Turn-on Characteristics vs. Collector Current

TYPICAL CHARACTERISTICS (Continued)

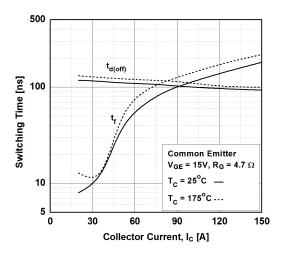


Figure 13. Turn-off Characteristics vs. Collector Current

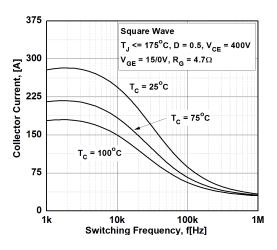


Figure 15. Load Current vs. Frequency

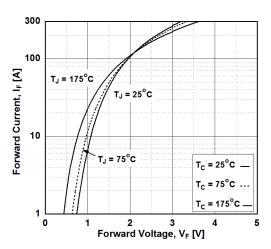


Figure 17. Forward Characteristics

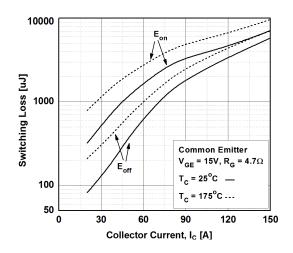


Figure 14. Switching Loss vs. Collector Current

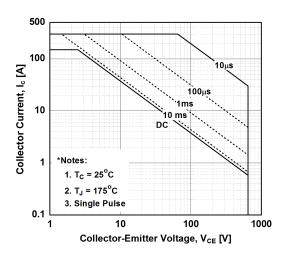


Figure 16. SOA Characteristics

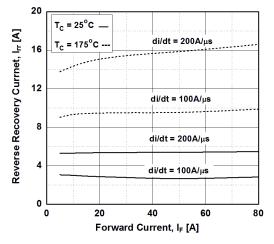
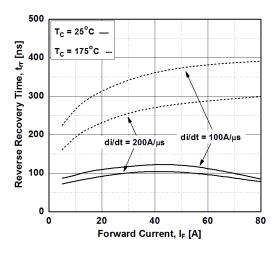


Figure 18. Reverse Recovery Current

TYPICAL CHARACTERISTICS (Continued)



2500
T_C = 25°C —
T_C = 175°C —
T

Figure 19. Reverse Recovery Time

Figure 20. Stored Charge

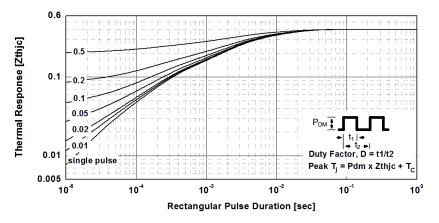


Figure 21. Transient Thermal Impedance of IGBT

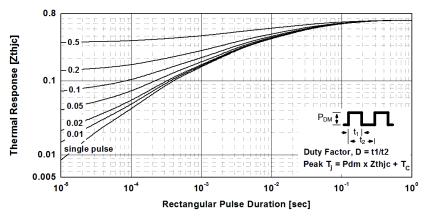
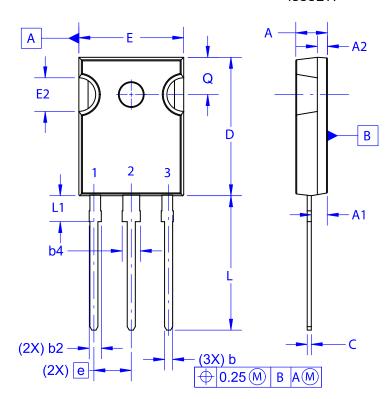


Figure 22. Transient Thermal Impedance of Diode



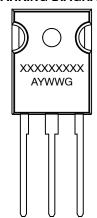
TO-247-3LD CASE 340CH **ISSUE A**





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
 D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC **MARKING DIAGRAM***



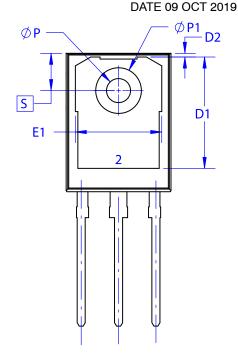
XXXX = Specific Device Code

= Assembly Location

WW = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.



| DIM | MILLIMETERS | | | | |
|------------|-------------|-------|-------|--|--|
| DIM | MIN | NOM | MAX | | |
| Α | 4.58 | 4.70 | 4.82 | | |
| A 1 | 2.29 | 2.475 | 2.66 | | |
| A2 | 1.40 | 1.50 | 1.60 | | |
| D | 20.32 | 20.57 | 20.82 | | |
| Е | 15.37 | 15.62 | 15.87 | | |
| E2 | 4.96 | 5.08 | 5.20 | | |
| e | ? | 5.56 | ? | | |
| L | 19.75 | 20.00 | 20.25 | | |
| L1 | 3.69 | 3.81 | 3.93 | | |
| ØΡ | 3.51 | 3.58 | 3.65 | | |
| Q | 5.34 | 5.46 | 5.58 | | |
| S | 5.34 | 5.46 | 5.58 | | |
| b | 1.17 | 1.26 | 1.35 | | |
| b2 | 1.53 | 1.65 | 1.77 | | |
| b4 | 2.42 | 2.54 | 2.66 | | |
| С | 0.51 | 0.61 | 0.71 | | |
| D1 | 13.08 | ~ | ~ | | |
| D2 | 0.51 | 0.93 | 1.35 | | |
| E1 | 12.81 | ~ | ~ | | |
| ØP1 | 6.61 | 6.73 | 6.85 | | |

| DOCUMENT NUMBER: | 98AON13853G | Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | | |
|------------------|-------------|---|-------------|--|--|
| DESCRIPTION: | TO-247-3LD | | PAGE 1 OF 1 | | |

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI., and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems. or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales